

Form Type	Distribute	Version	ersion 2.0		Ref		IPC 175.		2A Sectionals		Manufacturino Info/ Material Info		Subsectionals	D, A
Supplier Information														
Company Name	TE Connectivi	Request Document I	D			Contac	t Name	Penica	a, John R	Con	tact Title		Mgr Environmen I Central Eng	tal Engineering,
Company Unique ID	TE Connectivi	Response I	Response Date		2015-09-29		Contact Email		jrpenica@te.com					
Contact Phone	Number	+1-717-592-	3266											
Supplier	true					Legal S	tatement							
Acceptance														
Legal Statemen								T1 · · ·				T. .		
way modify exist	ng purchase sp	document is base ecifications or exi	a upo isting	n reasonar contractual	or othe	ry of our r agreem	ents term	nis int s betwe	ormation is en TE Conr	nectiv	ect to change. ity (or its affili	ated	s information doe I companies) and	es not in any lits customers.
	1	1.		I			duct			1				
Manufacturer Item number	1-770849-5	1-770849-5 Amount		4184.62		Version		- 1		Identity				
Manufacturer Item Name	15P SL156 HS W/LOC RAMF W/TBS			mg		Mfr Site			Authority		nority			
Date		UOM	UOM Each											
EURoHS-0508		Product(s) meets EU RoHS requirement without any exemptions												
ChinaRoHS- 0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products													
EUREACH-1214 REACH Candidate Substances of Very High Concern ARE NOT Yet Reviewed														
L CTD 000 MC		May Tatal			Man		ng Inform	ation		\A/-				
J-STD-020 MSL Rating		Max Total a Wave Time				Ramp Rate			Wave Addition		e itional Info			
Classification Temp		Max Wave Solder Time	Max Wave Solder Time		0.0		Ramp Down Rate			Psl Rating Reflow				
Max Time Within 5		Psl Rating Wave	Psl Rating Wave				Package Designator		Size		1	0.0		
Time Above 217	,	Reflow Additional I	Reflow Additional Info				Preheat Max Temp			Terminal E Alloy		NAC		
Preheat Duration			bulk Solder Termination		NAC		Nbr or Reflow Cycles			Terminal Plating		NAC		
Preheat Min Temp		Nbr of Instances			0		Component Temp Spike		Sha		hape NA		IAC	
•	•				F		Disclosur	е						
Sub- Item/Material/ Substance	Level	Name		stance gory	Substa CAS	ance	Substar Concen		Quantity		Mass per U	nit	UOM	Exemption
Sub-Item	1	Nylon Compound							1.0		4184.62		mg	
Material	2	PA	Journa						1.0	4184.62			mg	
Substance	3	Water	l l				1		1.0		13.65023		mg	
Substance	3	2H-Azepin-2- one, hexahydro-	Supplier		105-60)-2	0.4637	1.0			19.40408		mg	
Substance	3	Siloxanes and Silicones, di- Me	Supp	olier	63148-	62-9 3.0E-4			1.0	0.01255386			mg	
Substance	3	Poly[imino(1,6-dioxo-1,6-hexanediyl)imino-1,6-hexanediyl]	Supplier		32131-17-2		0.9451	1.0		39.54884			mg	
Substance	3	Benzenepropa namide, N,N- 1,6- hexanediylbis[3 ,5-bis(1,1- dimethylethyl)- 4-hydroxy-	Supplier		23128-74-7		0.4004		1.0	16.75522			mg	
Substance	3	1,2- Ethanediamine	Supplier		107-15-3		0.0033		1.0		0.13809		mg	
Substance	3	Phosphoric acid, sodium salt, hydrate (1:2:12)	Supplier		10039-32-4		0.025	1.0			1.04616		mg	
Substance	3	Octadecanoic acid, calcium salt (2:1)	Supplier		1592-23-0		0.2012	1.0			8.41946		mg	
Substance	3	Octadecanami de, N,N-1,2- ethanediylbis-	Supp	Supplier)-5	0.1901	1.0			7.95496		mg	

Substance	3	1,3,5-Triazine- 2,4,6(1H,3H,5 H)-trione, compd. with 1,3,5-triazine- 2,4,6-triamine (1:1)	Supplier	37640-57-6	9.0717	1.0	379.61617	mg	
Substance	3	Hexanedioic acid, polymer with hexahydro-2H- azepin-2-one and 1,6- hexanediamine		24993-04-2	88.373	1.0	3698.07423	mg	